



Material declaration form

General Information			
IPC	1752	Version	2
Form type*	Distribute		
Sectionals*	Material information	Subsectionals*	A-D
	Manufacturing information		*: Required Field

Supplier Information			
Company name*	STMicroelectronics	Response Date*	2026-03-02
Contact name*	Refer to Supplier Comment section		Refer to Supplier Comment section
Contact phone*	Refer to Supplier Comment section	Contact email*	Refer to Supplier Comment section
Authorized representative*	Antonella Lanzafame	Representative title	Material Declaration Champion
Representative phone*	Refer to Supplier Comment section	Representative email*	Refer to Supplier Comment section
Supplier comment	Online Technical Support - STMicroelectronics : http://www.st.com/web/en/support/support.html		

Uncertainty statement

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Legal statement

Supplier acceptance* true Legal declaration* Standard

Supplier certifies that it gathered the provided information and such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part(s), and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part(s), the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.



Product				
Mfr item number	Mfr item name	Version	Manufacturing site	date
TSV61AICT	IYW8*V61AAL	B	ZS1A	2026-03-02
	Amount	UoM	Unit type	ST ECOPACK Grade
	6	mg	Each	ECOPACK® 3
Identity	Authority			
Comment	ECOPACK® 3 is STMicroelectronics trade name for ROHS compliant device without use of any ROHS exemption and without Halogen nor Antimony			

Manufacturing information			
J-STD-020 MSL rating	Classification temperature	Number of reflow cycles	
1	260	3	
Bulk solder termination	Terminal plating	Terminal base alloy	Comment
Not Applicable	Nickel/Palladium/Gold (Ni/Pd/Au)	Copper Alloy	

Package designator	Package size	Number of instances	Shape
DSO	2 x 1.26	5	Gull wing
Comment			
Comment	W8 SOT 323 5LDS		

QueryList : RoHS Directive 2011/65/EU- 8 June 2011 – Annex II amended by Delegated Directive 2015/863 - 31 March 2015		Response
1 - Product(s) meets EU RoHS requirement without any exemptions		true
2 - Product(s) meets EU RoHS requirements except lead in solder and this usage may qualify under the lead in solder '7b' exemption (other selected exemptions may apply)		false
3 - Product(s) meets EU RoHS requirements by application of the selected exemption(s)		false
4 - Product(s) does not meet EU RoHS requirements and is not under exemptions		false
Exemption Id.	Description	

QueryList : ELV directive : 2000/53/EC amended 2020/363_March 2020		Response
1 - Product(s) meets EU ELV requirements without any exemptions		true
2 - Product(s) meets EU RoHS requirements by application of the selected exemption(s)		false
Exemption Id.	Description	

QueryList : California Prop65 list, dated 3rd January 2025		Response	
1 - The product does not contain identified substance from California Prop 65 List, no exposure to consumers is foreseen		false	
2 - The product is containing below substance(s) from California Prop 65 List, no exposure to consumers is foreseen		true	
Substance	amount in product (mg)	Application	ppm in product
Nickel	0.029	Leadframe	4833

QueryList : Chinese RoHS , references : SJT 11364 – 2014 and GBT 26572 – 2014		Response		
QUERY		Response		
1 - Product(s) requires marking for the presence of restricted substances and must be marked with an Environmental Protection Use Period under China's Measures for Administration of the control of pollution by Electronic Information Products		false		
2 - Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products		false		
Hazardous substance				
Lead (Pb)	Cadmium (Cd)	Mercury (Hg)	Hexavalent Chromium (Cr VI)	PBB & PBDE
O	O	O	O	O

QueryList : REACH-4th February 2026				Response
1 - Product(s) does not contain REACH Substances Of Very High Concern above the limits per the definition within REACH				true
CategoryLevel_Name	CategoryLevel_Threshold	amount in product (mg)	Application	ppm in product
2 - Product(s) does not contain REACH Substances Of Very High Concern in any Embedded article nor Homogeneous Material above the limits per the definition within REACH				true
CategoryLevel_Name	CategoryLevel_Threshold	Amount in embedded article / Homogeneous material (mg)	Application - article / Homogeneous material	ppm in article /Homogeneous material



QueryList : Responsible metals sourcing	Response
The component is containing at least one of the following metals : Cobalt , Gold , Tantalum , Tin , Tungsten.	true
The following metals are present is the component :	Gold,

QueryList : Korea Chemical Control Act_ 27 Dec 2017 update	Response
The Product does contain at least one of the substances listed in Chemical Control Act	false

QueryList : China GB 33372-2020 Limit standard for volatile organic compounds content in adhesives - 4 March 2020 application date 1st December 2020	Response
The product contains adhesives identified under GB 33372	True
All the adhesive impacted complies with GB 33372	true

QueryList:Stockholm Convention Persistent Organic Pollutants (POP)	Response
Product is compliant with Annex A, B and C of Stockholm Convention Persistent Organic Pollutants	true

QueryList: EU Ship Recycling Regulation No. 1257/2013	Response
Product contains hazardous materials listed in Annex II of EU Ship Recycling Regulation No.1257/2013 and 2009/16/EC Directive	False

Other Fluorinated Substances	Response
QUERY	Response
The product is containing fluorinated substance.	False
Substance Name, CAS	

BPA Declaration	Response
Product does not contain Bisphenol A (Isopropylidenediphenol)	True

Montreal Protocol	Response
Product does not contain Ozone Depleting Substances based on Annex I to Annex VII of EU REGULATION (EC) No 1005/2009	True

Environmental Protection Agency:Toxic Substances Control Act (TSCA). Section 6(h)	Response
Product does not contain Phenol, isopropylated, phosphate (3:1)	True



Material Composition Declaration : note : Substance present with less 0.001mg will not be declared in this document						Mfr Item Name	IYW8*V611AAL			6.0000		4999999.0	1000000.0
Homogeneous material	Material group	Mass	Unit of measure	Level	Substance category	Substance	CAS	Exempt	Mass	Unit of measure	Concentration in homogeneous material (ppm)	Concentration in product (ppm)	
Die	M-011 Other inorganic materials	0.414	mg	supplier	die	Silicon(Si)	7440-21-3		0.401	mg	968599	66833	
				supplier	metallisation	Aluminium(Al)	7429-90-5		0.004	mg	9662	667	
				supplier	Passivation	Silicon nitride(Si3N4)	12033-89-5		0.001	mg	2415	167	
				supplier	passivation	Silicon oxide	7631-86-9		0.008	mg	19324	1333	
Leadframe	M-004 Copper and its alloys	2.561	mg	supplier	alloy	Copper	7440-50-8		2.466	mg	962905	411000	
				supplier	alloy	Iron	7439-89-6		0.058	mg	22647	9667	
				supplier	alloy	Iron Phosphide	26508-33-8		0.001	mg	390	167	
				supplier	alloy	Zinc	7440-66-0		0.003	mg	1171	500	
				supplier	alloy	Nickel	7440-02-0		0.029	mg	11324	4833	
				supplier	alloy	Palladium	5/37440		0.003	mg	1171	500	
				supplier	alloy	Gold	7440-57-5		0.001	mg	390	167	
				supplier	alloy	Aluminium oxide	1344-28-1		0.006	mg	300000	1000	
Die attach	M-011 Other inorganic materials	0.020	mg	supplier	glue	Diethylene glycol	112-15-2		0.008	mg	400000	1333	
				supplier	glue	Epoxy resin (1-25068-38-6	25068-38-6		0.001	mg	50000	167	
				supplier	glue	Epoxy resin (1-Proprietary	Proprietary		0.004	mg	200000	667	
				supplier	glue	Aromatic amine	Proprietary		0.001	mg	50000	167	
Bonding wires	M-008 Precious metals	0.030	mg	supplier	wire	Gold (Au)	7440-57-5		0.030	mg	1000000	5000	
Encapsulation	M-011 Other inorganic materials	2.975	mg	supplier	mold compound	Epoxy resin-1	Proprietary		0.080	mg	26891	13333	
				supplier	mold compound	Epoxy resin-2	Proprietary		0.080	mg	26891	13333	
				supplier	mold compound	Epoxy resin-3	Proprietary		0.080	mg	26891	13333	
				supplier	mold compound	Phenol resin	Proprietary		0.155	mg	52101	25833	
				supplier	mold compound	Silica	60676-86-0		2.572	mg	864538	428667	
supplier	mold compound	Carbon Black	1333-86-4		0.008	mg	2689	1333					